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Details

E·XFI

Product Status	Obsolete
Core Processor	80C51
Core Size	8-Bit
Speed	40MHz
Connectivity	CANbus, SPI, UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	36
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	2K x 8
RAM Size	2.25K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-LQFP
Supplier Device Package	44-VQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/at89c51cc03u-rdtim

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Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

Pin Configuration

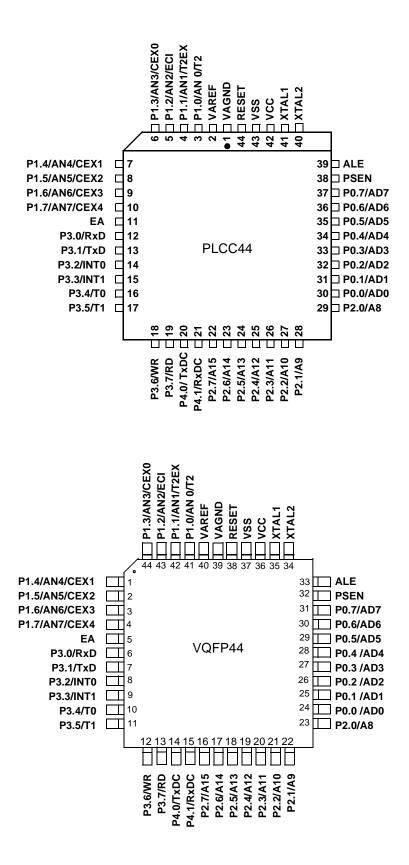






Table 1. SFR Mapping

	0/8 ⁽²⁾	1/9	2/A	3/B	4/C	5/D	6/E	7/F	
F8h	IPL1 xxxx x000	CH 0000 0000	CCAP0H 0000 0000	CCAP1H 0000 0000	CCAP2H 0000 0000	CCAP3H 0000 0000	CCAP4H 0000 0000		FFh
F0h	B 0000 0000		ADCLK xxx0 0000	ADCON x000 0000	ADDL 0000 0000	ADDH 0000 0000	ADCF 0000 0000	IPH1 xxxx x000	F7h
E8h	IEN1 xxxx x000	CL 0000 0000	CCAP0L 0000 0000	CCAP1L 0000 0000	CCAP2L 0000 0000	CCAP3L 0000 0000	CCAP4L 0000 0000		EFh
E0h	ACC 0000 0000								E7h
D8h	CCON 0000 0000	CMOD 00xx x000	CCAPM0 x000 0000	CCAPM1 x000 0000	CCAPM2 x000 0000	CCAPM3 x000 0000	CCAPM4 x000 0000		DFh
D0h	PSW 0000 0000	FCON 0000 0000	EECON xxxx xx00	FSTA xxxx xx00	SPCON 0001 0100	SPSCR 0000 0000	SPDAT xxxx xxxx		D7h
C8h	T2CON 0000 0000	T2MOD xxxx xx00	RCAP2L 0000 0000	RCAP2H 0000 0000	TL2 0000 0000	TH2 0000 0000	CANEN1 x000 0000	CANEN2 0000 0000	CFh
C0h	P4 xxx1 1111	CANGIE xx00 000x	CANIE1 x000 0000	CANIE2 0000 0000	CANIDM1 xxxx xxxx	CANIDM2 xxxx xxxx	CANIDM3 xxxx xxxx	CANIDM4 xxxx xxxx	C7h
B8h	IPL0 x000 0000	SADEN 0000 0000	CANSIT1 0000 0000	CANSIT2 0000 0000	CANIDT1 xxxx xxxx	CANIDT2 xxxx xxxx	CANIDT3 xxxx xxxx	CANIDT4 xxxx xxxx	BFh
B0h	P3 1111 1111	CANPAGE 0000 0000	CANSTCH xxxx xxxx	CANCONCH xxxx xxxx	CANBT1 xxxx xxxx	CANBT2 xxxx xxxx	CANBT3 xxxx xxxx	IPH0 x000 0000	B7h
A8h	IEN0 0000 0000	SADDR 0000 0000	CANGSTA x0x0 0000	CANGCON 0000 0x00	CANTIML 0000 0000	CANTIMH 0000 0000	CANSTMPL 0000 0000	CANSTMPH 0000 0000	AFh
A0h	P2 1111 1111	CANTCON 0000 0000	AUXR1 xxxx 00x0	CANMSG xxxx xxxx	CANTTCL 0000 0000	CANTTCH 0000 0000	WDTRST 1111 1111	WDTPRG xxxx x000	A7h
98h	SCON 0000 0000	SBUF 0000 0000		CANGIT 0x00 0000	CANTEC 0000 0000	CANREC 0000 0000		CKCON1 xxxx xxx0	9Fh
90h	P1 1111 1111								97h
88h	TCON 0000 0000	TMOD 0000 0000	TL0 0000 0000	TL1 0000 0000	TH0 0000 0000	TH1 0000 0000	AUXR x001 0100	CKCON0 0000 0000	8Fh
80h	P0 1111 1111	SP 0000 0111	DPL 0000 0000	DPH 0000 0000				PCON 00x1 0000	87h
L	0/8 ⁽²⁾	1/9	2/A	3/B	4/C	5/D	6/E	7/F	-

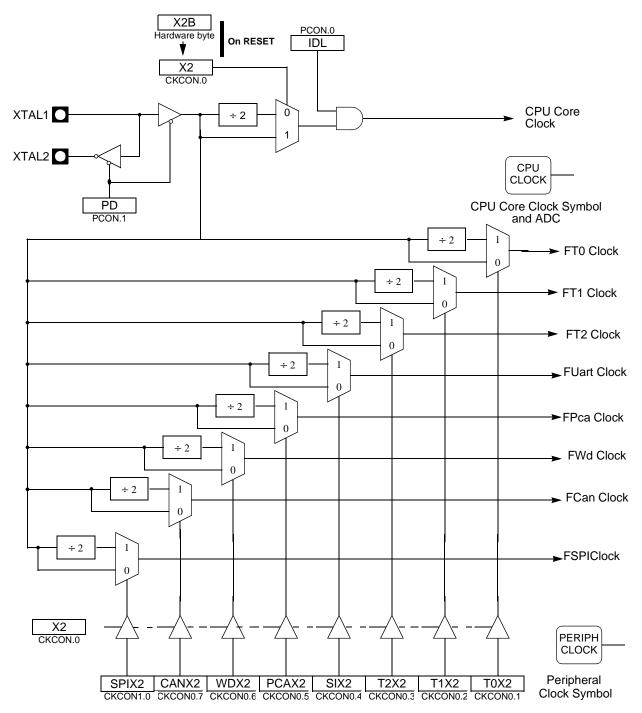
Reserved

Note: 1. Do not read or write Reserved Registers

 These registers are bit-addressable. Sixteen addresses in the SFR space are both byte-addressable and bit-addressable. The bit-addressable SFR's are those whose address ends in 0 and 8. The bit addresses, in this area, are 0x80 through to 0xFF.



Figure 5. Clock CPU Generation Diagram





External Space

Memory Interface

The external memory interface comprises the external bus (port 0 and port 2) as well as the bus control signals (RD#, WR#, and ALE).

Figure 10 shows the structure of the external address bus. P0 carries address A7:0 while P2 carries address A15:8. Data D7:0 is multiplexed with A7:0 on P0. Table 5 describes the external memory interface signals.

Figure 10. External Data Memory Interface Structure

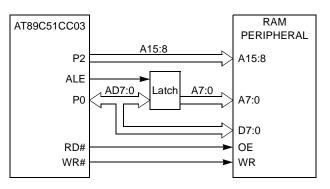


Table 5.	External Data	Memory	Interface	Signals
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Signal Name	Туре	Description	Alternative Function
A15:8	0	Address Lines Upper address lines for the external bus.	P2.7:0
AD7:0	I/O	Address/Data Lines Multiplexed lower address lines and data for the external memory.	P0.7:0
ALE	0	Address Latch Enable ALE signals indicates that valid address information are available on lines AD7:0.	-
RD#	0	Read Read signal output to external data memory.	P3.7
WR#	0	Write Write signal output to external memory.	P3.6

External Bus Cycles

This section describes the bus cycles the AT89C51CC03 executes to read (see Figure 11), and write data (see Figure 12) in the external data memory.

External memory cycle takes 6 CPU clock periods. This is equivalent to 12 oscillator clock period in standard mode or 6 oscillator clock periods in X2 mode. For further information on X2 mode.

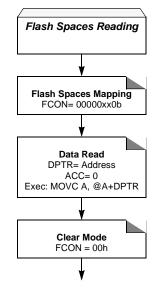
Slow peripherals can be accessed by stretching the read and write cycles. This is done using the M0 bit in AUXR register. Setting this bit changes the width of the RD# and WR# signals from 3 to 15 CPU clock periods.

For simplicity, the accompanying figures depict the bus cycle waveforms in idealized form and do not provide precise timing information. For bus cycle timing parameters refer to the Section "AC Characteristics" of the AT89C51CC03 datasheet.

Power Down Request	Before entering in Power Down (Set bit PD in PCON register) the user should check that no write sequence is in progress (check BUSY=0), then check that the column latches are reset (FLOAD=0 in FSTA register. Launch a reset column latches to clear FLOAD if necessary.
Reading the Flash Spaces	
User	The following procedure is used to read the User space:
	 Read one byte in Accumulator by executing MOVC A,@A+DPTR with A+DPTR=read@.
	Note: FCON is supposed to be reset when not needed.
Extra Row	The following procedure is used to read the Extra Row space and is summarized in Figure 28:
	 Map the Extra Row space by writing 02h in FCON register.
	 Read one byte in Accumulator by executing MOVC A,@A+DPTR with A = 0 and DPTR = FF80h to FFFFh.
	Clear FCON to unmap the Extra Row.
Hardware Security Byte	The following procedure is used to read the Hardware Security space and is summarized in Figure 28:
	 Map the Hardware Security space by writing 04h in FCON register.
	• Read the byte in Accumulator by executing MOVC A @A+DPTR with A = 0 and

 Read the byte in Accumulator by executing MOVC A,@A+DPTR with A = 0 and DPTR = 0000h.

Figure 28. Clear FCON to unmap the Hardware Security Byte.Reading Procedure



Flash Protection from Parallel Programming

The three lock bits in Hardware Security Byte (see "In-System Programming" section) are programmed according to Table 17 provide different level of protection for the onchip code and data located in FM0 and FM1.

The only way to write this bits are the parallel mode. They are set by default to level 4



Table 31. TMOD Register

TMOD (S:89h) Timer/Counter Mode Control Register

7	6	5	4	3	2	1	0	
GATE1	C/T1#	M11	M01	GATE0	C/T0#	M10	M00	
Bit Number	Bit Mnemonic	Description						
7	GATE1	Clear to enal	Timer 1 Gating Control Bit Clear to enable Timer 1 whenever TR1 bit is set. Set to enable Timer 1 only while INT1# pin is high and TR1 bit is set.					
6	C/T1#	Clear for Tim	•	elect Bit Timer 1 count Timer 1 count				
5	M11		le Select Bit					
4	M01	<u>M11 M01</u> 0 0 0 1 1 0 1 1	M11 0M01 Operating mode000Mode 0: 8-bit Timer/Counter (TH1) with 5-bit prescaler (TL1).01010Mode 1: 16-bit Timer/Counter.10Mode 2: 8-bit auto-reload Timer/Counter (TL1) (1)					
3	GATE0	Clear to enal		Bit henever TR0 b ter 0 only while		high and TRC) bit is set.	
2	C/T0#	Clear for Tim	•	elect Bit Timer 0 count Timer 0 count				
1	M10	Timer 0 Mod M10 M00 0 0		<u>mode</u> bit Timer/Cour 5-bit Timer/Cou		5-bit prescal	er (TL0).	
0	M00	1 0 1 1	Mode 2: 8- Mode 3: Tl	bit auto-reload L0 is an 8-bit T g Timer 1's TR	Timer/Counter			

1. Reloaded from TH1 at overflow.

2. Reloaded from TH0 at overflow.

Reset Value = 0000 0000b





Registers

Table 36. T2CON Register

T2CON (S:C8h) Timer 2 Control Register

7	6	5	4	3	2	1	0
TF2	EXF2	RCLK	TCLK	EXEN2	TR2	C/T2#	CP/RL2#
Bit Number	Bit Mnemonic	Description					
7	TF2	Must be clea	rflow Flag et if RCLK=1 of red by softwa vare on timer	re.			
6	EXF2	EXEN2=1. Set to cause is enabled.	apture or a re	eload is cause ector to timer re.	, ,		
5	RCLK		timer 1 overfl	ow as receive v as receive cl		•	
4	TCLK		timer 1 overfl	ow as transmi v as transmit c			
3	EXEN2	Clear to igno Set to cause	a capture or	bit T2EX pin for t reload when a used to clock t	negative tran		X pin is
2	TR2	Timer 2 Run Clear to turn Set to turn of					
1	C/T2#	Clear for time		bit input from inte (input from T2		tem: F _{OSC}).	
0	CP/RL2#	If RCLK=1 of timer 2 overf Clear to auto EXEN2=1.	low. p-reload on tin	bit P/RL2# is igno ner 2 overflow e transitions or	s or negative	transitions on	

Reset Value = 0000 0000b Bit addressable



Table 39. TL2 Register

TL2 (S:CCh) Timer 2 Low Byte Register

7	6	5	4	3	2	1	0
-	-	-	-	-	-	-	-
Bit Number	Bit Mnemonic	Description					
7-0		Low Byte of	Timer 2.				

Reset Value = 0000 0000b Not bit addressable

Table 40. RCAP2H Register

RCAP2H (S:CBh) Timer 2 Reload/Capture High Byte Register

7	6	5	4	3	2	1	0
-	-	-	-	-	-	-	-
Bit Number	Bit Mnemonic	Description					
7-0		High Byte of	Timer 2 Reloa	ad/Capture.			

Reset Value = 0000 0000b Not bit addressable

Table 41. RCAP2L Register

RCAP2L (S:CAн) TIMER 2 Reload/Capture Low Byte Register

7	6	5	4	3	2	1	0
-	-	-	-	-	-	-	-
Bit Number	Bit Mnemonic	Description					
7-0		Low Byte of	Timer 2 Reloa	d/Capture.			

Reset Value = 0000 0000b Not bit addressable

Watchdog Timer During Power-down Mode and Idle

In Power-down mode the oscillator stops, which means the WDT also stops. While in Power-down mode, the user does not need to service the WDT. There are 2 methods of exiting Power-down mode: by a hardware reset or via a level activated external interrupt which is enabled prior to entering Power-down mode. When Power-down is exited with hardware reset, the Watchdog is disabled. Exiting Power-down with an interrupt is significantly different. The interrupt shall be held low long enough for the oscillator to stabilize. When the interrupt is brought high, the interrupt is serviced. To prevent the WDT from resetting the device while the interrupt pin is held low, the WDT is not started until the interrupt is pulled high. It is suggested that the WDT be reset during the interrupt service for the interrupt used to exit Power-down.

To ensure that the WDT does not overflow within a few states of exiting powerdown, it is best to reset the WDT just before entering powerdown.

In the Idle mode, the oscillator continues to run. To prevent the WDT from resetting AT89C51CC03 while in Idle mode, the user should always set up a timer that will periodically exit Idle, service the WDT, and re-enter Idle mode.

Register

Table 44. WDTPRG Register

WDTPRG (S:A7h)

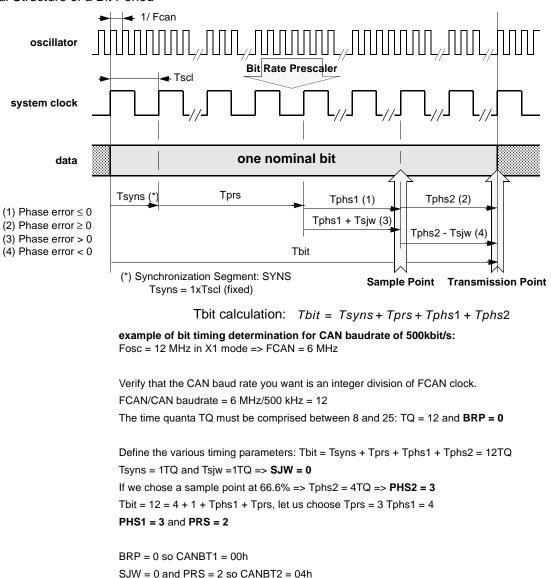
Watchdog Timer Duration Programming Register

7	6	5	4	3	2	1	0	
-	-	-	-	-	S2	S1	S0	
Bit Number	Bit Mnemonic	Description						
7	-	Reserved The value rea	ad from this b	it is indetermi	nate. Do not s	et this bit.		
6	-	Reserved The value rea	ad from this b	it is indetermi	nate. Do not s	et this bit.		
5	-	Reserved The value rea	Reserved The value read from this bit is indeterminate. Do not set this bit.					
4	-	Reserved The value rea	ad from this b	it is indetermi	nate. Do not s	et this bit.		
3	-	Reserved The value rea	ad from this b	it is indetermi	nate. Do not s	et this bit.		
2	S2	-	Watchdog Timer Duration selection bit 2 Work in conjunction with bit 1 and bit 0.					
1	S1	-	Watchdog Timer Duration selection bit 1 Work in conjunction with bit 2 and bit 0.					
0	SO		imer Duratio unction with b	n selection b it 1 and bit 2.	it O			

Reset Value = XXXX X000b



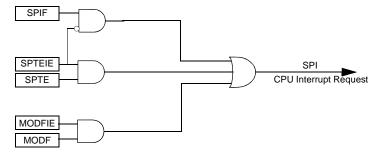




PHS2 = 3 and PHS1 = 3 so CANBT3 = 36h



Figure 66. SPI Interrupt Requests Generation



Registers

Serial Peripheral Control Register (SPCON)

- Three registers in the SPI module provide control, status and data storage functions. These registers are describe in the following paragraphs.
- The Serial Peripheral Control Register does the following:
- Selects one of the Master clock rates
- Configure the SPI Module as Master or Slave
- Selects serial clock polarity and phase
- Enables the SPI Module
- Frees the SS pin for a general-purpose

Table 92 describes this register and explains the use of each bit

Table 92. SPCON Register

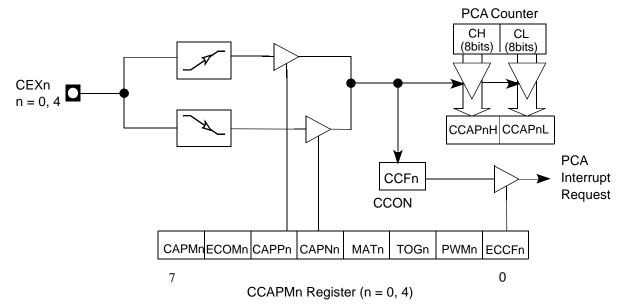
SPCON - Serial Peripheral Control Register (0D4H)

7	6	5	4	3	2	1	0	
SPR2	SPEN	SSDIS	MSTR	CPOL	СРНА	SPR1	SPR0	
Bit Number	Bit Mn	emonic	Description					
7	SF	PR2	Serial Peripheral Rate 2 Bit with SPR1 and SPR0 define the clock rate (See bits SPR1 and SPR0 for detail).					
6	SF	PEN	Serial Peripheral Enable Cleared to disable the SPI interface (internal reset of the SPI). Set to enable the SPI interface.					
5	SS	DIS	$\overline{SS} \text{ Disable}$ Cleared to enable \overline{SS} in both Master and Slave modes. Set to disable \overline{SS} in both Master and Slave modes. In Slave mode, this bit has no effect if CPHA ='0'. When SSDIS is set, no MODF interrupt request is generated.					
4	MS	STR	Serial Peripheral Master Cleared to configure the SPI as a Slave. Set to configure the SPI as a Master.					





Figure 69. PCA Capture Mode



16-bit Software Timer Mode

The PCA modules can be used as software timers by setting both the ECOM and MAT bits in the modules CCAPMn register. The PCA timer will be compared to the module's capture registers and when a match occurs an interrupt will occur if the CCFn (CCON SFR) and the ECCFn (CCAPMn SFR) bits for the module are both set.

Figure 70. PCA 16-bit Software Timer and High Speed Output Mode

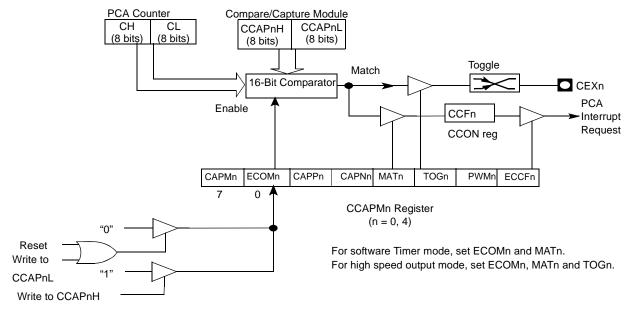


Figure 73. ADC Description

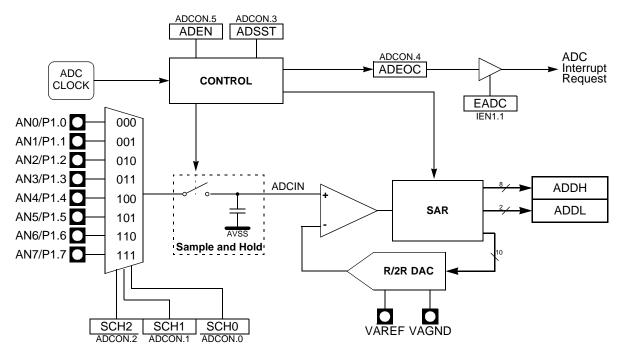
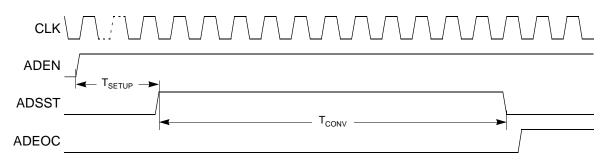


Figure 74 shows the timing diagram of a complete conversion. For simplicity, the figure depicts the waveforms in idealized form and do not provide precise timing information. For ADC characteristics and timing parameters refer to the Section "AC Characteristics" of the AT89C51CC03 datasheet.

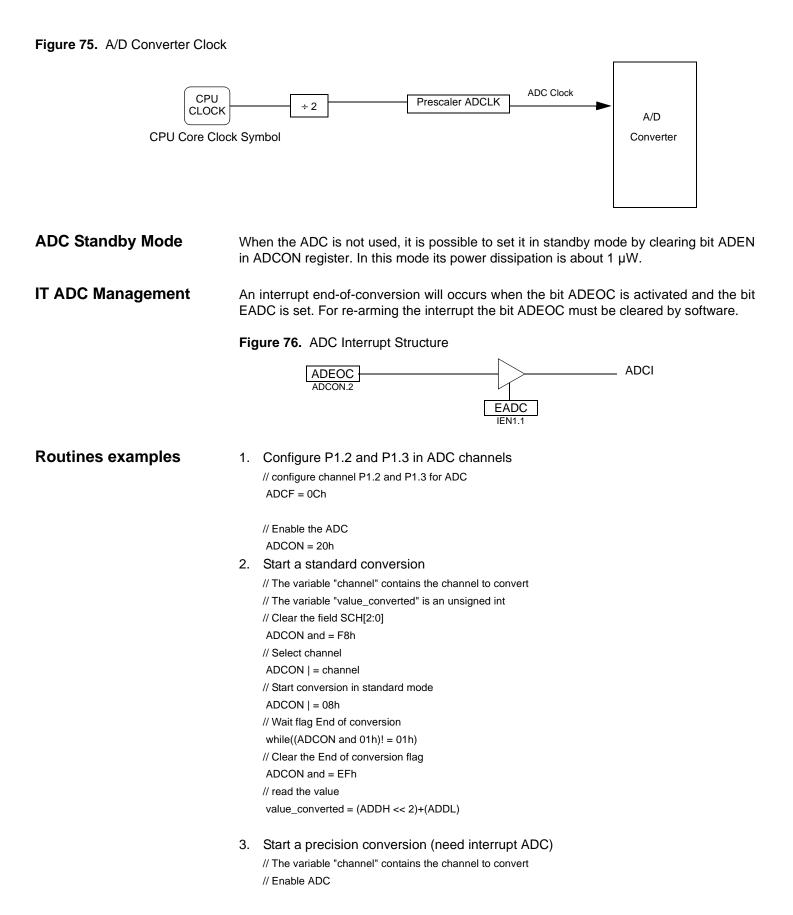
Figure 74. Timing Diagram



Note: Tsetup min = 4 us

Tconv=11 clock ADC = 1sample and hold + 10 bit conversion The user must ensure that 4 us minimum time between setting ADEN and the start of the first conversion.







Each of the interrupt sources can be individually enabled or disabled by setting or clearing a bit in the Interrupt Enable register. This register also contains a global disable bit which must be cleared to disable all the interrupts at the same time.

Each interrupt source can also be individually programmed to one of four priority levels by setting or clearing a bit in the Interrupt Priority registers. The Table below shows the bit values and priority levels associated with each combination.

IPH.x	IPL.x	Interrupt Level Priority	
0	0	0 (Lowest)	
0	1	1	
1	0	2	
1	1	3 (Highest)	

Table 108. Priority Level Bit Values

A low-priority interrupt can be interrupted by a high priority interrupt but not by another low-priority interrupt. A high-priority interrupt cannot be interrupted by any other interrupt source.

If two interrupt requests of different priority levels are received simultaneously, the request of the higher priority level is serviced. If interrupt requests of the same priority level are received simultaneously, an internal polling sequence determines which request is serviced. Thus within each priority level there is a second priority structure determined by the polling sequence, see Table 109.

Interrupt Name	Interrupt Address Vector	Priority Number
external interrupt (INT0)	0003h	1
Timer0 (TF0)	000Bh	2
external interrupt (INT1)	0013h	3
Timer1 (TF1)	001Bh	4
PCA (CF or CCFn)	0033h	5
UART (RI or TI)	0023h	6
Timer2 (TF2)	002Bh	7
CAN (Txok, Rxok, Err or OvrBuf)	003Bh	8
ADC (ADCI)	0043h	9
CAN Timer Overflow (OVRTIM)	004Bh	10
SPI interrupt	0053h	11

 Table 109.
 Interrupt priority Within level





External Program Memory Characteristics

Table 118. Symbol Description

Symbol	Parameter
Т	Oscillator clock period
T _{LHLL}	ALE pulse width
T _{AVLL}	Address Valid to ALE
T _{LLAX}	Address Hold After ALE
T _{LLIV}	ALE to Valid Instruction In
T _{LLPL}	ALE to PSEN
T _{PLPH}	PSEN Pulse Width
T _{PLIV}	PSEN to Valid Instruction In
T _{PXIX}	Input Instruction Hold After PSEN
T _{PXIZ}	Input Instruction Float After PSEN
T _{AVIV}	Address to Valid Instruction In
T _{PLAZ}	PSEN Low to Address Float

Table 119. AC Parameters for a Fix Clock (F = 40 MHz)

Symbol	Min	Мах	Units
Т	25		ns
T _{LHLL}	40		ns
T _{AVLL}	10		ns
T _{LLAX}	10		ns
T _{LLIV}		70	ns
T _{LLPL}	15		ns
T _{PLPH}	55		ns
T _{PLIV}		35	ns
T _{PXIX}	0		ns
T _{PXIZ}		18	ns
T _{AVIV}		85	ns
T _{PLAZ}		10	ns

Symbol	Туре	Standard Clock	X2 Clock	X parameter	Units
T _{RLRH}	Min	6 T - x	3 T - x	20	ns
T _{WLWH}	Min	6 T - x	3 T - x	20	ns
T _{RLDV}	Max	5 T - x	2.5 T - x	25	ns
T _{RHDX}	Min	х	х	0	ns
T _{RHDZ}	Max	2 T - x	T - x	20	ns
T _{LLDV}	Max	8 T - x	4T -x	40	ns
T _{AVDV}	Max	9 T - x	4.5 T - x	60	ns
T _{LLWL}	Min	3 T - x	1.5 T - x	25	ns
T _{LLWL}	Max	3 T + x	1.5 T + x	25	ns
T _{AVWL}	Min	4 T - x	2 T - x	25	ns
T _{QVWX}	Min	T - x	0.5 T - x	15	ns
T _{QVWH}	Min	7 T - x	3.5 T - x	25	ns
T _{WHQX}	Min	T - x	0.5 T - x	10	ns
T _{RLAZ}	Max	х	х	0	ns
T _{WHLH}	Min	T - x	0.5 T - x	15	ns
T _{WHLH}	Max	T + x	0.5 T + x	15	ns

 Table 123.
 AC Parameters for a Variable Clock



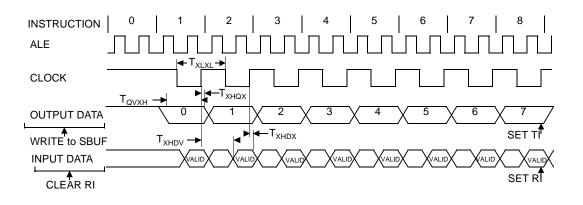
Symbol	Min	Мах	Units
T _{XLXL}	300		ns
T _{QVHX}	200		ns
T _{XHQX}	30		ns
T _{XHDX}	0		ns
T _{XHDV}		117	ns

Table 125. AC Parameters for a Fix Clock (F = 40 MHz)

Table 126. AC Parameters for a Variable Clock

Symbol	Туре	Standard Clock	X2 Clock	X parameter for -M range	Units
T _{XLXL}	Min	12 T	6 T		ns
T _{QVHX}	Min	10 T - x	5 T - x	50	ns
T _{XHQX}	Min	2 T - x	T - x	20	ns
T _{XHDX}	Min	х	х	0	ns
T _{XHDV}	Max	10 T - x	5 T- x	133	ns

Shift Register Timing Waveforms



External Clock Drive Characteristics (XTAL1)

Table 127. AC Parameters

Symbol	Parameter	Min	Мах	Units
T _{CLCL}	Oscillator Period	25		ns
T _{CHCX}	High Time	5		ns
T _{CLCX}	Low Time	5		ns
T _{CLCH}	Rise Time		5	ns
T _{CHCL}	Fall Time		5	ns
T _{CHCX} /T _{CLCX}	Cyclic ratio in X2 mode	40	60	%





STANDARD NOTES FOR PLCC

1/ CONTROLLING DIMENSIONS : INCHES

2/ DIMENSIONING AND TOLERANCING PER ANSI Y 14.5M - 1982.

3/ "D" AND "E1" DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTUSIONS. MOLD FLASH OR PROTUSIONS SHALL NOT EXCEED 0.20 mm (.008 INCH) PER SIDE.



STANDARD NOTES FOR PQFP/ VQFP / TQFP / DQFP

1/ CONTROLLING DIMENSIONS : INCHES

2/ ALL DIMENSIONING AND TOLERANCING CONFORM TO ANSI Y 14.5M - 1982.

3/ "D1 AND E1" DIMENSIONS DO NOT INCLUDE MOLD PROTUSIONS. MOLD PROTUSIONS SHALL NOT EXCEED 0.25 mm (0.010 INCH). THE TOP PACKAGE BODY SIZE MAY BE SMALLER THAN THE BOTTOM PACKAGE BODY SIZE BY AS MUCH AS 0.15 mm.

4/ DATUM PLANE "H" LOCATED AT MOLD PARTING LINE AND COINCIDENT WITH LEAD, WHERE LEAD EXITS PLASTIC BODY AT BOTTOM OF PARTING LINE.

5/ DATUM "A" AND "D" TO BE DETERMINED AT DATUM PLANE H.

6/ DIMENSION " f " DOES NOT INCLUDE DAMBAR PROTUSION ALLOWABLE DAMBAR PROTUSION SHALL BE 0.08mm/.003" TOTAL IN EXCESS OF THE " f " DIMENSION AT MAXIMUM MATERIAL CONDITION . DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT.